



# Product Change Notification

## 111765 - 02

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**Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.**

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# Product Change Notification

**Change Notification #:** 111765 - 02  
**Change Title:** Intel® Desktop Board DQ77MK, Boxed & Bulk  
PCN 111765-02, Product Design  
PCB Change  
**Reason for Revision: Implementation Date Change**  
**Date of Publication:** December 05, 2012

**Key Characteristics of the Change:**  
Product Design

**Forecasted Key Milestones:**

<b>Date Customer Must be Ready to Receive Post-Conversion Material:</b>	<b>Jan 14, 2013</b>
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**Description of Change to the Customer:**

**Reason for Revision: Implementation Date Change**

The PCB is being changed to provide additional margin for the VR (voltage regulator) when exceeding the VR temperatures under stress conditions.

**Customer Impact of Change and Recommended Action:**

This change has been thoroughly evaluated to ensure there is no quality, reliability, or functional implication to our customers. Intel is not recommending additional qualification of these changes on platforms received from Intel.

Intel will attempt to deplete pre-conversion material before shipping post-conversion material but there is a possibility of Intel shipping mixed inventory. Therefore, customers will need to manage and migrate to the post-conversion material as soon as possible.

Milestone dates are estimates and subject to change based on business and operational conditions.

**Products Affected / Intel Ordering Codes:**

Product Code	MM#	Pre Change AA	Post Change AA
BOXDQ77MK	918171	G39642-401	G39642-500
BLKDQ77MK	918174	G39642-401	G39642-500

**PCN Revision History:**

<b>Date of Revision:</b>	<b>Revision Number:</b>	<b>Reason:</b>
September 18, 2012	00	Originally Published PCN
October 26, 2012	01	The PCB Change has not yet implemented and an update will be provided at a future date.
December 5, 2012	02	Implementation Date Change